

Low Cost Single Trip Point Temperature Sensor

Features:

- Temperature Set Point Easily Programs with a Single External Resistor
- Operates with 2.7V Power Supply (TC624)
- TO-220 Package for Direct Mounting to Heatsink (TC622XAT) or Standard 8-Pin PDIP and SOIC

Applications:

- Power Supply Over-Temperature Detection
- Consumer Electronics
- Fire/Heat Detection
- · UPSs, Amplifiers, Motors
- · CPU Thermal Management in PCs

General Description:

The TC622 and TC624 are programmable solid-state temperature sensors designed to replace mechanical switches in sensing and control applications. Both devices integrate the temperature sensor with a voltage reference and all required detector circuitry. The desired temperature set point is set by the user with a single external resistor.

Ambient temperature is sensed and <u>compared</u> to the programmed set point. The OUT and OUT outputs are driven to their active state when the measured temperature exceeds the programmed set point.

The TC622 has a power supply voltage range of 4.5V to 18.0V while the TC624 operates over a power supply range of 2.7V to 4.5V. Both devices are usable over a temperature range of -40°C to +125°C (TC622VXX, TC624VXX). Both devices feature low supply current making them suitable for portable applications.

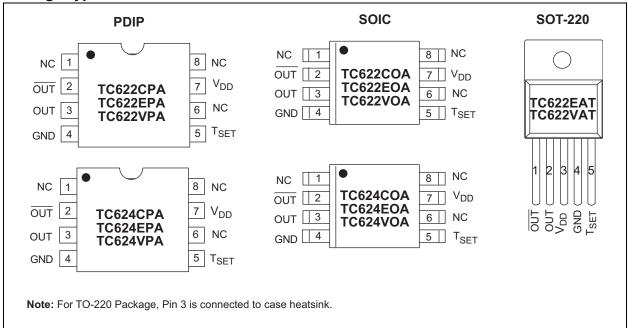
Eight-pin through-hole and surface mount packages are available. The TC622 is also offered in a 5-pin TO-220 package.

The TC622 and TC624 are single point temperature detectors ideal for use in a wide variety of applications.

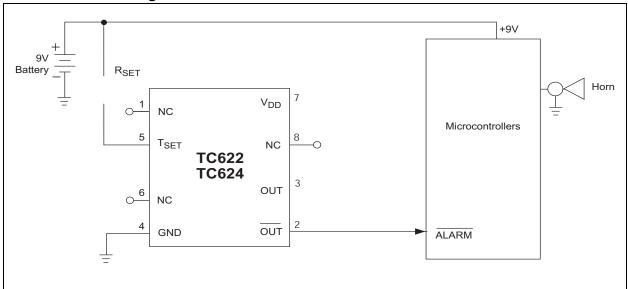
Device Selection Table

Part Number	Voltage Operation	Package	Ambient Temperature
TC622COA	4.5V to 18V	8-Pin SOIC	0°C to +70°C
TC622CPA	4.5V to 18V	8-Pin PDIP	0°C to +70°C
TC622EAT	4.5V to 18V	5-PinTO-220	-40°C to +85°C
TC622EOA	4.5V to 18V	8-Pin SOIC	-40°C to +85°C
TC622EPA	4.5V to 18V	8-Pin PDIP	-40°C to +85°C
TC622VAT	4.5V to 18V	5-Pin TO-220	-40°C to +125°C
TC622VOA	4.5V to 18V	8-Pin SOIC	-40°C to +125°C
TC622VPA	4.5V to 18V	8-Pin PDIP	-40°C to +125°C
TC624COA	2.7V to 4.5V	8-Pin SOIC	0°C to +70°C
TC624CPA	2.7V to 4.5V	8-Pin PDIP	0°C to +70°C
TC624EOA	2.7V to 4.5V	8-Pin SOIC	-40°C to +85°C
TC624EPA	2.7V to 4.5V	8-Pin PDIP	-40°C to +85°C
TC624VOA	2.7V to 4.5V	8-Pin SOIC	-40°C to +125°C
TC624VPA	2.7V to 4.5V	8-Pin PDIP	-40°C to +125°

Package Type



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings*

Supply Voltage (TC622)	20V
(TC624)	
Input Voltage Any Input (GND - 0.3)	V) to (V _{DD} +0.3V)
Operating Temperature	40°C to +125°C
C Version	0°C to +70°C
E Version	40°C to +85°C
V Version	40°C to +125°C
Storage Temperature	65°C to +150°C

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

TC622/TC624 ELECTRICAL SPECIFICATIONS

Electi	Electrical Characteristics: Over operating temperature range, unless otherwise specified.						
Sym	Parameter	Device	Min	Тур	Max	Unit	Test Conditions
V_{DD}	Supply Voltage Range	TC622 TC624	4.5 2.7		18 4.5	V	
I _{DD}	Supply Current	TC622 TC624		200 170	600 300	μА	$5.0V \le V_{DD} \le 18V$ $2.7V \le V_{DD} \le 4.5V$
V _{OH}	Output Voltage (High)	TC622	0.90 x V _{DD} 0.80 x V _{DD}		_	V	$\begin{array}{l} 5.0V \leq V_{DD} \leq 18V, \ \ \text{-}40^{\circ}C \leq T_{A} \leq \text{+}125^{\circ}C, \\ I_{OH} = 250 \ \mu\text{A} \\ I_{OH} = 500 \ \mu\text{A} \end{array}$
V _{OL}	Output Voltage (Low)	TC622			0.15 x V _{DD} 0.30 x V _{DD} 0.35 x V _{DD}	V	-40 °C \le T _A \le +85°C, I _{OL} = 500 μA I _{OL} = 1 mA -40 °C \le T _A \le +125°C, I _{OL} = 1 mA
V _{OH}	Output Voltage (High)	TC624	— 0.90 x V _{DD} 0.80 x V _{DD}		_	٧	$2.7V \le V_{DD} \le 4.5V$ - $40^{\circ}C \le T_{A} \le +125^{\circ}C, \ I_{OH} = 250 \ \mu A$ $I_{OH} = 500 \ \mu A$
V _{OL}	Output Voltage (Low)	TC624	_ _ _	_ _ _	0.1 x V _{DD} 0.2 x V _{DD} 0.25 x V _{DD}	V	-40 °C \leq T _A \leq +85°C, I _{OL} = 500 μA I _{OL} = 1 mA -40 °C \leq T _A \leq +125°C, I _{OL} = 1 mA
T _{SET}	Absolute Accuracy	TC622 TC624	T - 5 T - 5	T ± 1 T ± 1	T + 5 T + 5	°C	T _{SET} = Programmed Temperature T _{SET} = Programmed Temperature
OUT	Trip Point Hysteresis	TC622 TC624		2 2		°C	

2.0 PIN DESCRIPTION

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin No. (8-Pin SOIC) (8-Pin PDIP)	Symbol	Description
1	NC	No Internal Connection.
2	OUT	Active low output.
3	OUT	Active high output.
4	GND	Ground Terminal.
5	T _{SET}	Temperature set point. Connect an external 1% resistor from T_{SET} to V_{CC} to set trip point.
6	NC	No Internal Connection.
7	V_{DD}	Power supply input.
8	NC	No Internal Connection.

Pin No. (5-Pin SOT-220)	Symbol	Description
1	OUT	Active low output.
2	OUT	Active high output.
3	V_{DD}	Power supply input.
4	GND	Ground Terminal.
5	T _{SET}	Temperature set point. Connect an external 1% resistor from T_{SET} to V_{CC} to set trip point.

3.0 DETAILED DESCRIPTION

3.1 Trip Point Programming

When the temperature of the device exceeds the programmed temperature trip point, T_{SET} , the OUT and OUT outputs are driven into their active states. The desired trip point temperature is programmed with a single external resistor connected between the T_{SET} input and V_{CC} . The relationship between the resistor value and the trip point temperature is given by Equation 3-1.

EQUATION 3-1:

$$R_{TRIP} = 0.5997 \text{ x T}^{2.1312}$$

Where:

R_{TRIP} = Programming resistor value in Ohms T = Desired trip temperature in degrees Kelvin.

For example, as shown in Figure 3-1, to program the device to trip at 50°C, the programming resistor is:

$$R_{TRIP} = 0.5997 \text{ x } ((50 + 273.15)^{2.1312}) = 133.65 \text{ k}\Omega$$

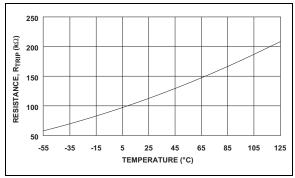


FIGURE 3-1: Programming Resistor Values vs. Temperature

3.2 Hysteresis

To prevent output "chattering" at the trip point temperature, the temperature detector in the TC622/TC624 has 2°C hysteresis (see Figure 3-2). The outputs are driven active when the temperature crosses the set point determined by the external resistor. As temperature declines below the set point, the hysteresis action will hold the outputs true until the temperature drops 2°C below the threshold.

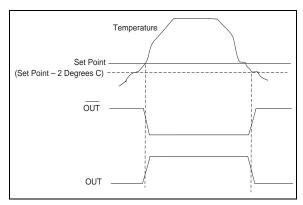


FIGURE 3-2: TC622/TC624 Hysteresis

4.0 TYPICAL APPLICATIONS

4.1 Over-Temperature Shutdown

The TC622 can be used to create a simple over-temperature shutdown circuit. In this circuit, temperature is sensed within the system enclosure (internal system ambient) or at the heatsink itself. When measured temperature exceeds a preset limit, a fault is indicated and the system shuts down.

Figure 4-1 illustrates an over-temperature shutdown circuit using the TC622 sensor in a single TO-220 package, allowing direct attachment to the heatsink surface. As shown, the TC622 outputs are driven active when the heatsink temperature equals the trip point temperature set by R_{TRIP}. When this happens, the crowbar circuit is activated, causing the supply output to fold back to zero. The TC622 outputs remain active until the heatsink temperature falls a minimum of 2°C (built-in hysteresis) below the trip point temperature, at which time the device again allows normal supply operation.

4.2 Cooling and Heating Applications

The TC622/TC624 can be used to control a DC fan as shown in Figure 4-2. The fan turns on when the sensed temperature rises above T_{SET} and remains on until the temperature falls below T_{SET} - 2°C.

Figure 4-3 shows the TC622 acting as a heater thermostat. Circuit operation is identical to that of the cooling fan application.

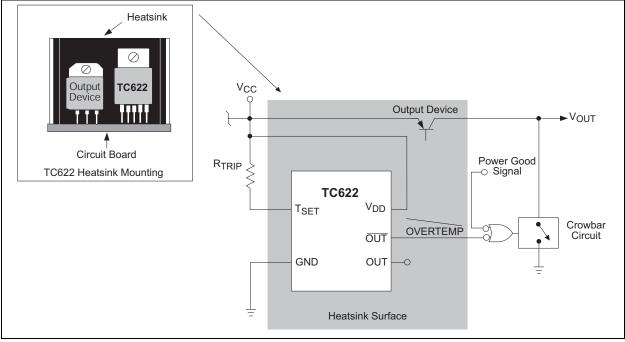


FIGURE 4-1: TC622 Power Supply Over-Temperature Shutdown

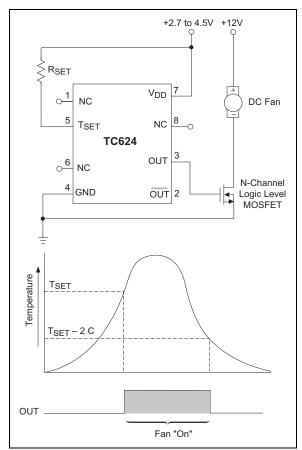


FIGURE 4-2: TC624 As A Fan Controller for Notebook PC

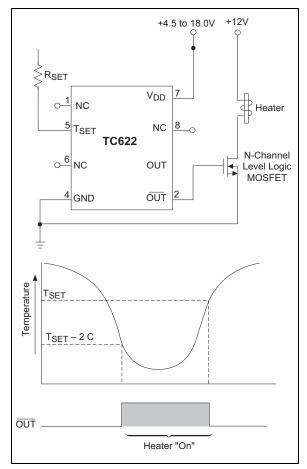


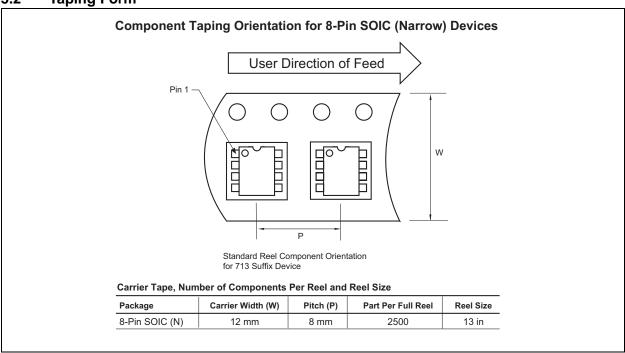
FIGURE 4-3: TC622 As A Heater Thermostat

5.0 PACKAGING INFORMATION

5.1 Package Marking Information

Package marking data not available at this time.

5.2 Taping Form



Dimensions: inches (mm)

5.3 Package Dimensions

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging 8-Pin Plastic DIP Pin 1 .260 (6.60) .240 (6.10) .045 (1.14) .070 (1.78) .030 (0.76) .040 (1.02) .310 (7.87) .290 (7.37) .400 (10.16) .348 (8.84) .200 (5.08) .140 (3.56) .040 (1.02) -.020 (0.51) .015 (0.38) 3° Min. .150 (3.81) .008 (0.20) .115 (2.92) .400 (10.16) .310 (7.87) .110 (2.79) .022 (0.56)

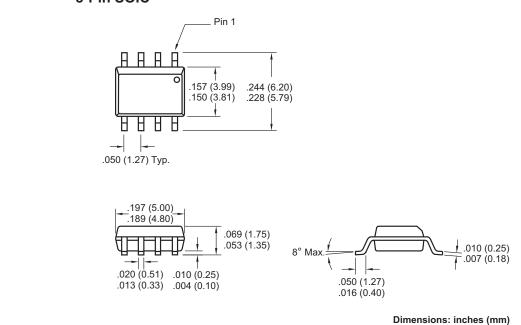
5.4 Package Dimensions (Continued)

.090 (2.29)

.015 (0.38)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

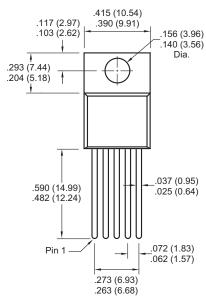
8-Pin SOIC

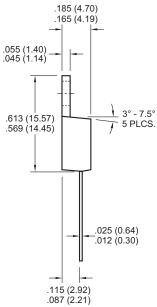


Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

5-Pin TO-220

.185 (4.70)
.165 (4.19)





Dimensions: inches (mm)

6.0 REVISION HISTORY

Revision D (December 2012)

Added a note to each package outline drawing.

NOTES:

SALES AND SUPPORT

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- Your local Microchip sales office
- 1. 2. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

New Customer Notification System

Register on our web site (www.microchip.com/cn) to receive the most current information on our products.

NOTES:

Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our
 knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data
 Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC³² logo, rfPIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MTP, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

Analog-for-the-Digital Age, Application Maestro, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, SQI, Serial Quad I/O, Total Endurance, TSHARC, UniWinDriver, WiperLock, ZENA and Z-Scale are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

GestIC and ULPP are registered trademarks of Microchip Technology Germany II GmbH & Co. & KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2001-2012, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

ISBN: 9781620768242

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



Worldwide Sales and Service

AMERICAS

Corporate Office

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277

Technical Support: http://www.microchip.com/

support

Web Address: www.microchip.com

Atlanta

Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Cleveland

Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Indianapolis

Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara

Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto

Mississauga, Ontario,

Canada

Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office

Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong

Tel: 852-2401-1200 Fax: 852-2401-3431

Australia - Sydney

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu

Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing

Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Hangzhou

Tel: 86-571-2819-3187 Fax: 86-571-2819-3189

China - Hong Kong SAR

Tel: 852-2943-5100 Fax: 852-2401-3431

China - Nanjing

Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao

Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai

Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang

Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen

Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan

Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian

Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

China - Xiamen

Tel: 86-592-2388138 Fax: 86-592-2388130

China - Zhuhai

Tel: 86-756-3210040 Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore

Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi

Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune

Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

Japan - Osaka

Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo

Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu

Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul

Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur

Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870

Fax: 60-4-227-4068

Philippines - Manila

Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore

Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu

Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung

Tel: 886-7-213-7828 Fax: 886-7-330-9305

Taiwan - Taipei

Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok

Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels

Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen

Tel: 45-4450-2828

France - Paris

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Munich

Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen

Tel: 31-416-690399 Fax: 31-416-690340

Spain - Madrid

Tel: 34-91-708-08-90 Fax: 34-91-708-08-91 **UK - Wokingham**

Tel: 44-118-921-5869 Fax: 44-118-921-5820

11/29/12